

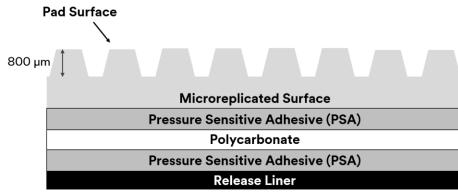
Product Description

3M™ Trizact™ Polishing Pad HT-800-PC is a microreplicated slurry lapping pad designed for finishing ultra-hard substrates such as sapphire and ceramics. Comprised of a microreplicated surface, this pad produces a good surface finish with high removal rates for an economical finishing solution when combined with a 3M™ Trizact™ Composite Slurry. This pad can be adhered to typical single- or double-sided lapping platens.

Key Advantages

- 800 micron cell depth for long pad life
- High removal rates
- · Good surface finish
- Low total thickness variation (TTV)
- Can be directly mounted onto flat/smooth and waffle pattern lapping plates
- · Easy pad replacement
- Pad diameters up to 50.5 inches (1282 mm)

3M™ Trizact™ Polishing Pad HT-800-PC



Not to scale

Product Construction/Material Description

3M™ Trizact™ Polishing Pad HT-800-PC

Property	Value
Pad size	Diameters up to 50.5 inches (1282 mm)

Applications

- A-, C- and R-plane sapphire fine lapping
- Fine lapping for silicon carbide (SiC), zirconia (ZrO₂), glass, silicon oxide and silicon materials
- 3M™ Trizact™ Polishing Pad HT-800-PC can be used with either single- or dual-sided lapping tools

Application Techniques

- Use with a 3M[™] Trizact[™] Composite Slurry*
- Clean platen and measure flatness before adhering pad
 - Recommended platen flatness for double-sided lapping is less than 10 microns for total thickness variations (TTVs) less than 5 microns

- Mount 3M[™] Trizact[™] Polishing Pad HT-800-PC and drill the slurry holes
 - o A unibit drill bit is recommended for drilling slurry holes
- Dress/condition the pad for about 10 minutes to planarize asperities by running empty resin/composite carriers (without workpiece) along with the Trizact slurry before first use
- 3M recommends that continuous operating temperature remains below 60°C (140°F)
- Pad can be reconditioned if TTVs exceed the specification

Typical Performance Characteristics

Note: The following technical information and data should be considered representative or typical only and should not be used for specification purposes. Final product specifications and testing methods will be outlined in the products Certificate of Analysis (COA). Contact your local 3M Technical Representative for this product's COA.

3M™ Trizact™ Polishing Pad HT-800-PC

Double-Sided Lapping					
	A-Plane		C-Plane		
3M™ Trizact™ Composite Slurry	Removal Rate* (µm/min)	Ra (nm)	Removal Rate* (µm/min)	Ra (nm)	
DGS-50, 1 μm	0.3	6	0.3	6	
DT-100, 1.5 μm	1.5	14	1.1	13	
DT-50, 3 μm	1.3	20	0.9	21	
DT-100, 3 μm	1.8	25	1.2	24	
Process Conditions					
Pad Diameter (OD x ID)		18.3" x 7.1" (465 mm x 180 mm)			
Platen Speed		65 rpm			
Slurry Flow Rate		5.4 ml/min (DT series), 5.1 ml/min (DGS series)			
Downforce		4.1 psi			
Polishing Time		30 min			
Wafers/Parts		Nine 2" (51 mm)	Nine 2" (51 mm) diameter sapphire		

^{*}Initial removal rates are higher with higher incoming Ra.

Storage and Shelf Life

The shelf life of 3M™ Trizact™ Polishing Pad HT-800-PC is 24 months from the date of manufacture when stored flat in the original packaging materials at 21°C (70°F) and 50% relative humidity.

3M recommends storing the Trizact polishing pad flat in its original packaging materials.

^{*}See the 3M™ Trizact™ Composite Slurry Technical Data Sheet for more information.

Regulatory: For regulatory information about this product, contact your 3M representative.

Technical Information: The technical information, recommendations and other statements contained in this document are based upon tests or experience that 3M believes are reliable, but the accuracy or completeness of such information is not guaranteed.

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60-5002-0909-7